**[William R. Miller & Martha L. Behr-Miller Scholarship](http://engineering.dev.engr.illinois.edu/ipeng/finances/miller-scholarship.html)**

A graduate from the University of Illinois mechanical engineering department, William Miller, spent a large part of the last eight years of his career in electro-mechanical devices working overseas. As he worked with engineers and managers in various countries, Mr. Miller discovered there was much to learn from them technologically as well as culturally.

Both William and Martha firmly believe that when we have friends in other nations of the world, then we are less likely to find reasons for war and the threat of war. The Miller’s strive to leave a friendlier world for future generations and feel this may be a way to help build international friendships.

Scholarship amounts vary from $1,000 to $2,000.

**Eligibility:**

* Mechanical Science and Engineering Students
* Minimum 3.3 GPA
* United State Citizen
* Must spend a semester or academic year in an approved location
* Once selected, must correspond via email with the Miller’s while abroad

**Approved Locations:**

* Austria
* China
* Denmark
* Germany
* Hong Kong
* Italy
* Japan
* Netherlands
* Norway
* Singapore
* South Korea
* Sweden
* Switzerland
* Taiwan

**How to Apply**

* No application necessary
* Notified if eligible